

Single Output Half-brick

MILITARY COTS DC/DC CONVERTER

16-40V Continuous Input Transient Input

16-50V

Output

36A Output 87% @ 18A / 86% @ 36A

Efficiency

Full Power Operation: -55°C to +100°C

The MilQor series of Mil-COTS DC/DC converters brings SynQor's field proven high-efficiency synchronous rectification technology to the Military/Aerospace industry. SynQor's ruggedized encased packaging approach ensures survivability in demanding environments. Compatible with the industry standard format, these converters operate at a fixed frequency, and follow conservative component derating guidelines. They are designed and manufactured to comply with a wide range of military standards.

Operational Features

- High efficiency, 86% at full rated load current
- Operating input voltage range: 16-40 V
- Fixed frequency switching provides predictable EMI
- No minimum load requirement

Mechanical Features

- Industry standard half-brick pin-out configuration
- 2.49" x 2.39" x 0.51" Size:

(63.1 x 60.6 x 13.0 mm)

- Total weight: 4.9 oz. (139 g)
- Flanged baseplate version available

Control Features

- On/Off control referenced to input return
- Remote sense for the output voltage
- Output voltage trim range of +10%, -10%
- Active current sharing (full feature option)
- Clock synchronization (full feature option)
- Start synchronization (full feature option)

Mil-COTS



Designed and Manufactured in the USA

Safety Features

- 2250V, 30 MΩ input-to-output isolation
- Certified 60950-1 requirement for basic insulation (see Standards and Qualifications page)

Protection Features

- Input under-voltage lockout
- Output current limit and short circuit protection
- Active back bias limit
- Output over-voltage protection
- Thermal shutdown

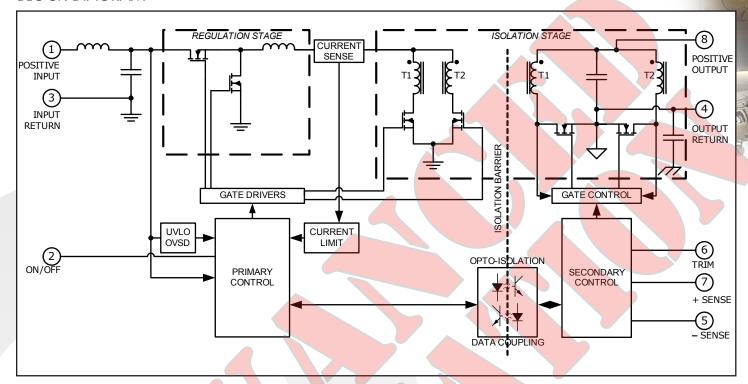
Screening/Qualification

- AS9100 and ISO 9001:2008 certified facility
- Qualification consistent with MIL-STD-883
- Available with S-Grade or M-Grade screening
- Temperature cycling per MIL-STD-883, Method 1010, Condition B, 10 cycles
- Burn-In at 100C baseplate temperature
- Final visual inspection per MIL-STD-2008
- Full component traceability

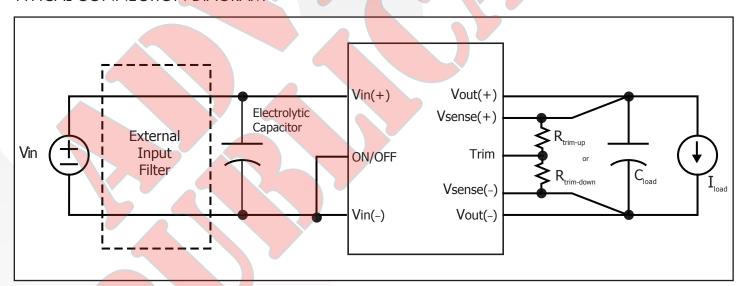
Output: 5V

Current: 36A

BLOCK DIAGRAM



TYPICAL CONNECTION DIAGRAM



Output: 5V Current: 36A

MCOTS-C-28-05-HP-FF ELECTRICAL CHARACTERISTICS

Tb = 25 °C, Vin = 28dc unless otherwise noted; full operating temperature range is -55 °C to +100 °C baseplate temperature with appropriate power derating. Specifications subject to change without notice.

Parameter	Min.	Тур.	Max.	Units	Notes & Conditions
ABSOLUTE MAXIMUM RATINGS		7.			
Input Voltage					
Non-Operating			60	V	Continuous
Operating			40	V	Continuous
Operating Transient Protection			55	V	1 s transient, square wave
Isolation Voltage					
Input to Output			2250	V dc	
Input to Base-Plate			2250	V dc	OF.
Output to Base-Plate			2250	V dc	
Operating Temperature	-55		+100	°C	Baseplate temperature
Storage Temperature	-65		+135	°C	Succession of the succession o
Voltage at ON/OFF input pin	-2		18	V	
INPUT CHARACTERISTICS			10		
Operating Input Voltage Range	16	28	40	V	50V transient for 1 s
Input Under-Voltage Lockout	20				
Turn-On Voltage Threshold	14.8	15.1	15.4	V	
Turn-Off Voltage Threshold	13.8	14.1	14.4	V	
Lockout Voltage Hysteresis		1.0		V	
Recommended External Input Capacitance		100		μF	Typical ESR $0.1-0.2 \Omega$
Input Filter Component Values (L\C)		0.5/13.2		μΗ\μΕ	Internal values; see Figure E
Maximum Input Current			13.3	Α	Vin min; trim up; in current limit
No-Load Input Current		180	225	mA	
Disabled Input Current		1.8	4	mA	
Response to Input Transient		0.2		V	See Figure 6
Input Terminal Ripple Current		160		mA	RMS
Recommended Input Fuse			20	A	Fast acting external fuse recommended
OUTPUT CHARACTERISTICS		15			
Output Voltage Set Point	4.95	5.00	5.05	V	
Output Voltage Regulation					
Over Line		±0.1	±0.3	%	
Over Load		±0.1	±0.3	%	
Over Temperature	-75		75	mV	
Total Output Voltage Range	4.875		5.125	V	Over sample, line, load, temperature & life
Output Voltage Ripple and Noise	11075		3.123		20 MHz bandwidth; see Note 1
Peak-to-Peak		55	110	mV	Full load
RMS		12	20	mV	Full load
Operating Output Current Range	0	12	36	A	Subject to thermal derating
Output DC Current-Limit Inception	40	44	48	A	Output voltage 10% Low
Output DC Current-Limit Shutdown Voltage	10	4	10	V	Cutput Voltage 10 /0 Low
Back-Drive Current Limit while Enabled		0.53		Ā	Negative current drawn from output
Back-Drive Current Limit while Disabled	0	0.4	50	mA	Negative current drawn from output
Maximum Output Capacitance			8000	μF	Vout nominal at full load (resistive load)
Output Voltage during Load Current Transient			3333	,	(
Step Change in Output Current (0.1 A/µs)		400		mV	50% to 75% to 50% Iout max
Settling Time		200		μs	To within 1% Vout nom
Output Voltage Trim Range	-10	230	10	μ3 %	Across Pins 8&4; Figure C; see Note 2
Output Voltage Remote Sense Range			10	%	Across Pins 8&4
Output Over-Voltage Protection	5.85	6.1	6.35	V	Over full temp range
EFFICIENCY			3.33		
100% Load		86		%	See Figure 1 for efficiency curve
50% Load		87		%	See Figure 1 for efficiency curve
55.5 L3uu		J,		, ,	Total . Igaic I for circles of carve

Note 1: Output is terminated with 1 µF ceramic and 15 µF low-ESR tantalum capacitors. For applications requiring reduced output voltage ripple and noise, consult SynQor applications support (e-mail: mqnbofae@synqor.com)

Note 2: Trim-up range is limited below 10% at low line and full load.

Output: 5V Current: 36A

MCOTS-C-28-05-HP-FF ELECTRICAL CHARACTERISTICS

Tb = 25 °C, Vin = 28dc unless otherwise noted; full operating temperature range is -55 °C to +100 °C baseplate temperature with appropriate power derating. Specifications subject to change without notice.

DYNAMIC CHARACTERISTICS Turn-On Transient	Parameter	Min.	Тур.	Max.	Units	Notes & Conditions
Turn-On Time Start-Up Inhibit Time Output Voltage Overshoot 0 0	DYNAMIC CHARACTERISTICS					
Start-Up Inhibit Time	Turn-On Transient					
Output Voltage Overshoot Solation Voltage (dielectric strength)	Turn-On Time		10		ms	Full load, Vout=90% nom.
Solation Voltage (dielectric strength) See Absolute Maximum Ratings	Start-Up Inhibit Time	200	230	250	ms	
Isolation Voltage (dielectric strength) See Absolute Maximum Ratings	Output Voltage Overshoot		0		%	Maximum Output Capacitance
Isolation Resistance 30 MΩ Isolation Capacitance (input to output) 1000 pF See Note 1 TEMPERATURE LIMITS FOR POWER DERATING CURVES Semiconductor Junction Temperature 125 °C Package rated to 150 °C Board Temperature 125 °C UL rated max operating temp 130 °C Transformer Temperature 125 °C UL rated max operating temp 130 °C Maximum Baseplate Temperature, Tb 100 °C FEATURE CHARACTERISTICS Switching Frequency 240 260 280 kHz For both input and isolation stage ON/OFF Control 2.4 18 V On-State Voltage 2.4 18 V ON/OFF Control Application notes Figures A & B Pull-Up Voltage 5 V Pull-Up Resistance 50 kΩ Over-Temperature Shutdown OTP Trip Point °C Average PCB Temperature Over-Temperature Shutdown Restart Hysteresis 10 °C Average PCB Temperature FULL FEATURE OPTION Clock Sync 280 300 320 kHz See Note 2 Current Share RELIABILITY CHARACTERISTICS Calcu	ISOLATION CHARACTERISTICS					
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Over-Temperature Shutdown Restart Hysteresis FULL FEATURE OPTION Clock Sync Current Share RELIABILITY CHARACTERISTICS Calculated MTBF per MIL-HDBK-217F 4.1 O°C kHz See Note 2 Half load KHZ See Note 2 Half load Fig. Ground Benign, 70°C Tb			50			
FULL FEATURE OPTION Clock Sync Current Share RELIABILITY CHARACTERISTICS Calculated MTBF per MIL-HDBK-217F 4.1 106 Hrs. Ground Benign, 70°C Tb			125			Average PCB Temperature
Clock Sync Current Share RELIABILITY CHARACTERISTICS Calculated MTBF per MIL-HDBK-217F 4.1 See Note 2 V Half load 106 Hrs. Ground Benign, 70°C Tb			10		°C	
Current Share RELIABILITY CHARACTERISTICS Calculated MTBF per MIL-HDBK-217F 4.1 106 Hrs. Ground Benign, 70°C Tb						
RELIABILITY CHARACTERISTICS Calculated MTBF per MIL-HDBK-217F 4.1 106 Hrs. Ground Benign, 70°C Tb		280		320		
Calculated MTBF per MIL-HDBK-217F 4.1 10 ⁶ Hrs. Ground Benign, 70°C Tb			3.0		V	Half load
Coloulated MTDE nor MIL HDDV 217E	·					•
Calculated WTSP per MIL-nobs-217F	Calculated MTBF per MIL-HDBK-217F		0.92		10 ⁶ Hrs.	Ground Mobile, 70°C Tb

Note 1: Higher values of isolation capacitance can be added external to the module.

Note 2: Higher values of isolation capacitance can be added external to the module.

STANDARDS COMPLIANCE

Parameter	Notes & Conditions

STANDARDS COMPLIANCE	
UL 60950-1:2007	Basic Insulation
CAN/CSA-C22.2 No. 60950-1:2007	
EN60950-1:2006/A11:2009/A1:2010	

Note: An external input fuse must always be used to meet these safety requirements. Contact SynQor for official safety certificates on new releases or download from the SynQor website.



Output: 5V

Current: 36A

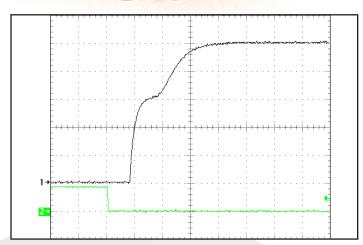


Figure 7: Typical startup waveform. Input voltage pre-applied, Ch 1: Vout (1V/div). Ch 2: ON OFF (5V/div).

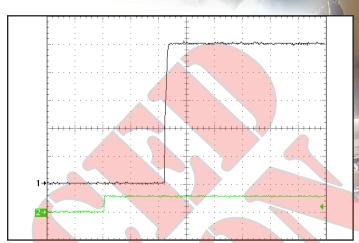


Figure 8: Turn-on transient at full resistive load and zero output capacitance initiated by Vin. ON/OFF Pin previously low. Ch 1: Vout (1V/div). Ch 2: Vin (50V/div).

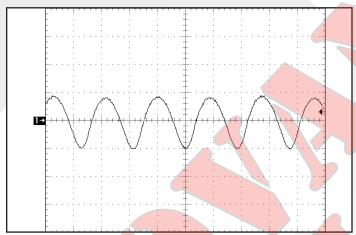


Figure 9: Input terminal current ripple, i_C, at full rated output current and nominal input voltage with SynQor MCOTS filter module (1 A/div). Bandwidth: 20MHz. See Figure 17.

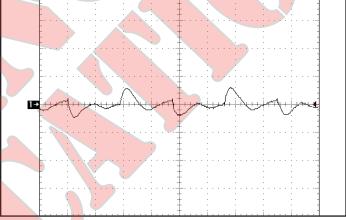


Figure 10: Output voltage ripple, Vout, at nominal input voltage and rated load current (100 mV/div). Load Capacitance: 1uf ceramic capacitor. Bandwidth: 20 MHz. See Figure 17.

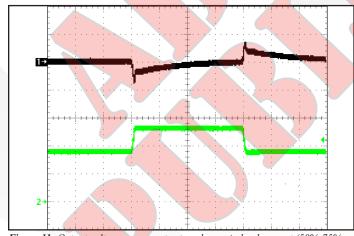


Figure 11: Output voltage response to step-change in load current (50%-75%-50% of lout(max); $dI/dt = 1 A/\mu s$). Load cap: 1 μ F ceramic and 15 μ F tantalum capacitors. Ch 1: Vout (0.5V/div), Ch 2: lout (10A/div).

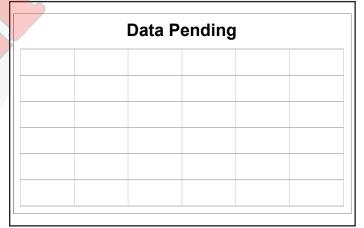


Figure 12: Output voltage response to step-change in input voltage (500V/ms) at full load current. Load cap: 100uf electrolytic capacitance. Ch1: Vout (.5V/div), Ch 2: Vin (20V/div).

Output: 5V

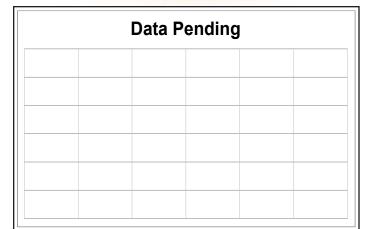


Figure 13: Magnitude of incremental output impedance ($Z_{out} = v_{out}$) for minimum, nominal, and maximum input voltage at full rated power.

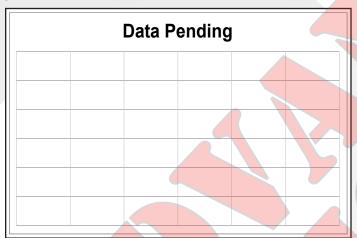


Figure 15: Magnitude of incremental reverse transmission ($RT = i_{in'}i_{out}$) for minimum, nominal, and maximum input voltage at full rated power.

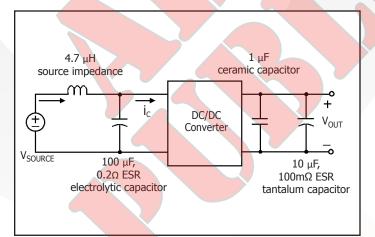


Figure 17: Test set-up diagram showing measurement points for Input Terminal Ripple Current (Figure 9) and Output Voltage Ripple (Figure 10).

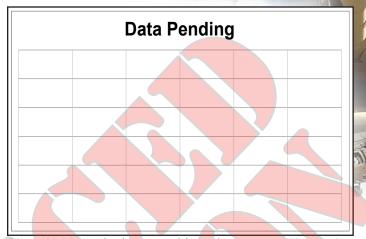


Figure 14: Magnitude of incremental forward transmission (FT = v_{out}/v_{in}) for minimum, nominal, and maximum input voltage at full rated power.

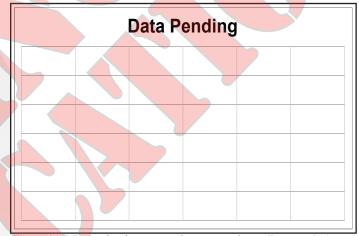


Figure 16: Magnitude of incremental input impedance $(Z_{in} = v_{in}/i_{in})$ for minimum, nominal, and maximum input voltage at full rated power.

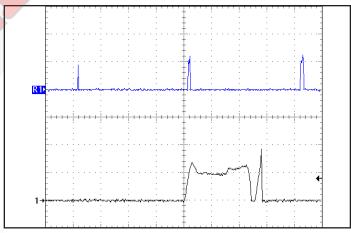


Figure 18: Load current (50A/div) as a function of time (2ms/div and 50ms/div) when the converter attempts to turn on into a 10 m Ω short circuit.

Output: 5V

Current: 36A

BASIC OPERATION AND FEATURES

This Mil-COTS converter series uses a two-stage power conversion topology. The first stage is a buck-converter that keeps the output voltage constant over variations in line, load, and temperature. The second stage uses a transformer to provide the functions of input/output isolation and voltage step-up or step-down to achieve the output voltage required.

Both the first stage and the second stage switch at a fixed frequency for predictable EMI performance. Rectification of the transformer's output is accomplished with synchronous rectifiers. These devices, which are MOSFETs with a very low on-state resistance, dissipate far less energy than Schottky diodes. This is the primary reason that the converter has such high efficiency, even at very low output voltages and very high output currents.

These converter are offered totally encased to withstand harsh environments and thermally demanding applications. Dissipation throughout the converter is so low that it does not require a heatsink for operation in many applications; however, adding a heatsink provides improved thermal derating performance in extreme situations.

This series of converters use the industry standard footprint and pin-out configuration.

CONTROL FEATURES

REMOTE ON/OFF (Pin 2): The ON/OFF input, Pin 2, permits the user to control when the converter is on or off. This input is referenced to the return terminal of the input bus, Vin(-). The ON/OFF signal is active low (meaning that a low turns the converter on). Figure A details four possible circuits for driving the ON/OFF pin. Figure B is a detailed look of the internal ON/OFF circuitry.

REMOTE SENSE(±) (Pins 7 and 5): The SENSE(±) inputs correct for voltage drops along the conductors that connect the converter's output pins to the load.

Pin 7 should be connected to Vout(+) and Pin 5 should be connected to Vout(-) at the point on the board where regulation is desired. A remote connection at the load can adjust for a voltage drop only as large as that specified in this datasheet, that is

$$[Vout(+) - Vout(-)] - [Vsense(+) - Vsense(-)] \le$$

Sense Range % x Vout

Pins 7 and 5 must be connected for proper regulation of the output voltage. If these connections are not made, the converter will deliver an output voltage that is slightly higher than its specified value.

Note: the output over-voltage protection circuit senses the voltage across the output (pins 8 and 4) to determine when it should trigger, not the voltage across the converter's sense leads (pins 7 and 5). Therefore, the resistive drop on the board should be small enough so that output OVP does not trigger, even during load transients.

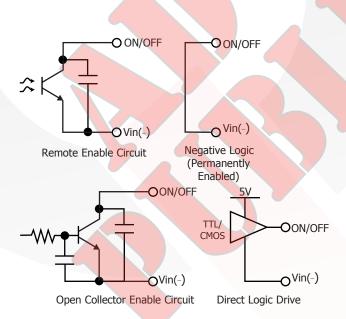


Figure A: Various circuits for driving the ON/OFF pin.

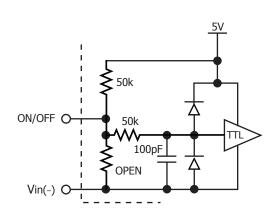


Figure B: Internal ON/OFF pin circuitry

Output: 5V Current: 36A

OUTPUT VOLTAGE TRIM (Pin 6): The TRIM input permits the user to adjust the output voltage across the sense leads up or down according to the trim range specifications.

To decrease the output voltage, the user should connect a resistor between Pin 6 and Pin 5 (SENSE(-) input). For a desired decrease of the nominal output voltage, the value of the resistor should be

$$R_{\text{trim-down}} = \left(\frac{511}{\Delta\%}\right) - 10.22 \text{ (k}\Omega)$$

where

$$\Delta\% = \left| \frac{\text{Vnominal} - \text{Vdesired}}{\text{Vnominal}} \right| \times 100\%$$

To increase the output voltage, the user should connect a resistor between Pin 6 and Pin 7 (SENSE(+) input). For a desired increase of the nominal output voltage, the value of the resistor should be

should be
$$R_{\text{trim-up}} = \left(\frac{5.11V_{\text{out}} \times (100 + \Delta\%)}{1.225\Delta\%} - \frac{511}{\Delta\%} - 10.22\right) (kΩ)$$
where

where $V_{out} = Nominal Output Voltage$

Trim graphs show the relationship between the trim resistor value and Rtrim-up and Rtrim-down, showing the total range the output voltage can be trimmed up or down.

<u>Note</u>: the TRIM feature does not affect the voltage at which the output over-voltage protection circuit is triggered. Trimming the output voltage too high may cause the over-voltage protection circuit to engage, particularly during transients.

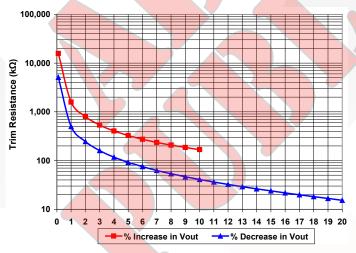


Figure C: Trim graph for trim-up, trim down.

It is not necessary for the user to add capacitance at the Trim pin. The node is internally bypassed to eliminate noise.

Total DC Variation of V_{our}: For the converter to meet its full specifications, the maximum variation of the dc value of V_{our} , due to both trimming and remote load voltage drops, should not be greater than that specified for the output voltage trim range.

PROTECTION FEATURES

Input Under-Voltage Lockout: The converter is designed to turn off when the input voltage is too low, helping avoid an input system instability problem, described in more detail in the application note titled "Input System Instability" on our website. The lockout circuitry is a comparator with dc hysteresis. When the input voltage is rising, it must exceed the typical Turn-On Voltage Threshold value (listed on the specifications page) before the converter will turn on. Once the converter is on, the input voltage must fall below the typical Turn-Off Voltage Threshold value before the converter will turn off.

Output Over-Voltage Limit: If the voltage across the output pins exceeds the Output Over-Voltage Protection threshold, the converter will immediately stop switching. This prevents damage to the load circuit due to 1) excessive series resistance in output current path from converter output pins to sense point, 2) a release of a short-circuit condition, or 3) a release of a current limit condition. Load capacitance determines exactly how high the output voltage will rise in response to these conditions. After 200 ms the converter will automatically restart.

Over-Temperature Shutdown: A temperature sensor on the converter senses the average temperature of the module. The thermal shutdown circuit is designed to turn the converter off when the temperature at the sensed location reaches the Over-Temperature Shutdown value. It will allow the converter to turn on again when the temperature of the sensed location falls by the amount of the Over-Temperature Shutdown Restart Hysteresis value.

Output Current Limit: The maximum current limit remains constant as the output voltage drops. However, once the impedance of the load across the output is small enough to make the output voltage drop below the specified Output DC Current-Limit Shutdown Voltage, the converter turns off.

The converter then enters a "hiccup" mode where it repeatedly turns on and off at a 5 Hz (nominal) frequency with 5% duty cycle until the short circuit condition is removed. This prevents excessive heating of the converter or the load board.

APPLICATION CONSIDERATIONS

Input System Instability: This condition can occur because any dc-dc converter appears incrementally as a negative resistance load. A detailed application note titled "Input System Instability" is available on the SynQor website which provides an understanding of why this instability arises, and shows the preferred solution for correcting it.

Application Circuits: Figure D provides a typical circuit diagram which details the input filtering and voltage trimming.

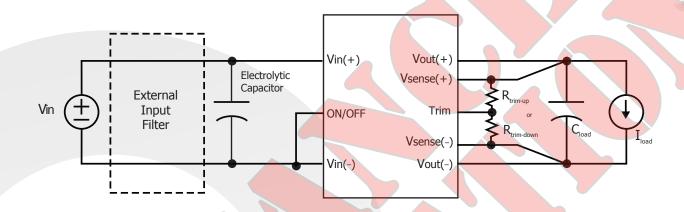


Figure D: Typical application circuit (negative logic unit, permanently enabled).

Input Filtering and External Capacitance: Figure E provides a diagram showing the internal input filter components. This filter dramatically reduces input terminal ripple current, which otherwise could exceed the rating of the converter's external electrolytic input capacitor. The recommended external input capacitance

is specified in the Input Characteristics section on the Electrical Characteristics page. More detailed information is available in the application note titled "EMI Characteristics" on the SynQor website.

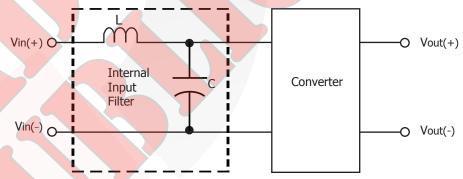


Figure E: Internal Input Filter Diagram

Output: 5V

Current: 36A

Startup Inhibit Period: The Startup Inhibit Period ensures that the converter will remain off for approximately 200 ms when it is shut down for any reason. When an output short is present, this generates a 5 Hz "hiccup" mode, which prevents the converter from overheating. In all, there are seven ways that the converter can be shut down, initiating a Startup Inhibit Period:

- Input Under-Voltage Lockout
- Input Over-Voltage Lockout
- Output Over-Voltage Protection
- Over Temperature Shutdown
- Current Limit
- Short Circuit Protection
- Turned off by the ON/OFF input

Figure F shows three turn-on scenarios, where a Startup Inhibit Period is initiated at t_0 , t_1 , and t_2 :

Before time t_o, when the input voltage is below the UVL threshold, the unit is disabled by the Input Under-Voltage Lockout feature. When the input voltage rises above the UVL threshold, the Input Under-Voltage lockout is released, and a Startup Inhibit Period is initiated. At the end of this delay, the ON/OFF pin is evaluated, and since it is active, the unit turns on.

At time t₁, the unit is disabled by the ON/OFF pin, and it cannot be enabled again until the Startup Inhibit Period has elapsed.

When the ON/OFF pin goes high after t₂, the Startup Inhibit Period has elapsed, and the output turns on within the typical Turn-On Time.

Thermal Considerations: The maximum operating base-plate temperature, T_B, is 100 °C. Refer to the thermal derating curve, Figure 5, to see the available output current at baseplate temperatures below 100 °C.

A power derating curve can be calculated for any heatsink that is attached to the base-plate of the converter. It is only necessary to determine the thermal resistance, R_{THa}, of the chosen heatsink between the base-plate and the ambient air for a given airflow rate. This information is usually available from the heatsink vendor. The following formula can then be used to determine the maximum power the converter can dissipate for a given thermal condition:

$$P_{diss}^{max} = \frac{T_{\scriptscriptstyle B} - T_{\scriptscriptstyle A}}{R_{TH_{\scriptscriptstyle BA}}}$$

This value of power dissipation can then be used in conjunction with the data shown in Figure 3 to determine the maximum load current (and power) that the converter can deliver in the given thermal condition.

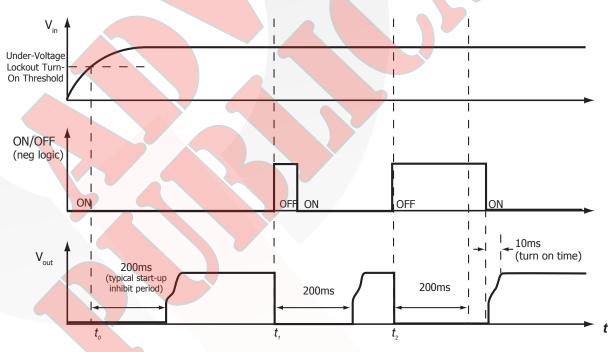


Figure F: Startup Inhibit Period (turn-on time not to scale)

FULL FEATURE APPLICATION NOTES

This section provides some baseic application information for the full-feature version of the MCOTS series converter.

All units in this product family include back-drive protection to simplify the user of multiple converters in a parallel or sequencing application. However, any voltage applied to the output of the converter should be kept below 120% of the rated output voltage of the converter.

In addition to back-drive protection, these units include the following features (pins):

Current Share (pin C): The active current share feature allows for N + 1 and parallel applications. To achieve load sharing, directly connect the I share pins of multiple units. The load current will share equally among the multiple units ($\pm 5\%$ at full rated current). It is important that the Vin(-) pins of the sharing units be directly connected and NOT placed outside of an EMI filter or other impedance path. The voltage at the I Share pin will range from 0 to 5 volts (at full rated current), referenced to the primary-side ground, Vin(-).

Start Sync (pin B): The Start Synchronization pin will allow a more consistent start-up sequence. To operate this feature, connect together the Start-Sync pins of multiple current-sharing units. This will permit immediate start-up with loads greater than the current limit of a single unit. Without this connection, any set of converters attempting to asynchronously start (or re-start) with a load greater than the current limit of a single unit will "hiccup". This "hiccup" mode will continue until one converter

attempts a start at the same time as the minimum number of additional units necessary to sustain the load condition. For example, three 50 amp units starting into a 90 amp load would require two units to simultaneously attempt a start. The Start Sync connection synchronizes these starting attempts and provides a more consistent and reliable start-up sequence. For details about the "hiccup" mode ore repeated startup attempts, please see the "Startup Inhibit Period" note in the Technical Specification.

Clock Sync (pin A): The External Clock Synchronization pin provides the ability for the user to control the EMI signature and synchronize sensitive circuitry to quiet periods in the converter operation. With this option, the converter can be synchronized to an external clock signal whose frequency is greater than that of the free-running internal clock. However, substantially raising the converter's frequency will reduce its efficiency. Therefore, the recommended frequency range for the external clock synchronization signal applied to this pin is listed in the Technical Specification.

The following requirements should also be met:

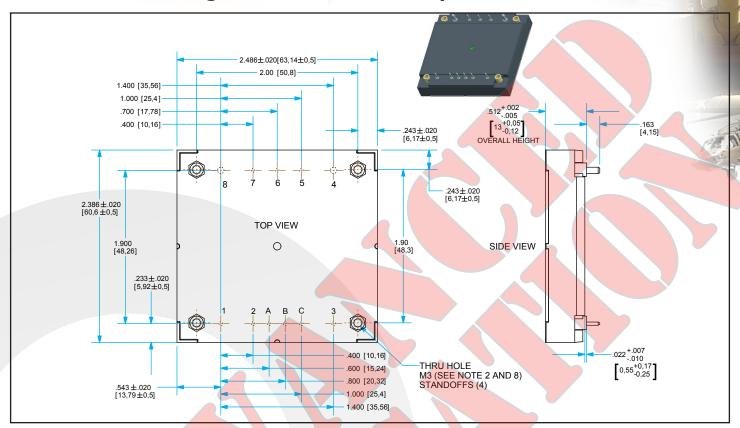
- The external clock signal should be referenced to the negative input voltage, Vin(-).
- The high level of the signal should be between 3.5V and 5.0V.
- The low level should be between -0.5V and +1.2V.
- Do not apply a clock signal lower than the specified frequency.



Output: 5V

Current: 36A

Mechanical Drawing - Normal Heatsink Option



NOTES

- 1) Applied torque per screw should not exceed 6in-lb (0.7 Nm).
- 2) Baseplate flatness tolerance is 0.004" (.10mm) TIR for surface.
- 3) Pins 1-3, 5-7, A, B, and C are 0.040" (1.02mm) diameter, with 0.080" (2.03mm) diameter standoff shoulders.
- 4) Pins 4 and 8 are 0.080" (2.03 mm) diameter with 0.125" (3.18 mm) diameter standoff shoulders.
- 5) All Pins: Material Copper Alloy; Finish Matte Tin over Nickel plate
- 6) Undimensioned components are shown for visual reference only.
- 7) Weight: 4.9 oz. (139 g) typical
- 8) Threaded or Non-Threaded options available
- 9) All dimensions in inches (mm)
 Tolerances: x.xx +/-0.02 in. (x.x +/-0.5mm)
 x.xxx +/-0.010 in. (x.xx +/-0.25mm)
- 10) Workmanship: Meets or exceeds IPC-A610 Class II
- Recommended pin length is 0.03" (0.76mm) greater than the PCB thickness.

PIN DESIGNATIONS

Pin	Name	Function
1	Vin(+)	Positive input voltage
2	ON/OFF	TTL input to turn converter on and off,
		referenced to Vin(-), with internal pull up.
Α	CLOCK SYNC	Clock synchronization
В	START SYNC	Startup synchronization
С	I SHARE	Single wire parallel signal
3	IN RTN	Input Return
4	OUT RTN	Output Return
5	SENSE(-)	Negative remote sense ¹
6	TRIM	Output voltage trim ²
7	SENSE(+)	Positive remote sense ³
8	Vout(+)	Positive output voltage

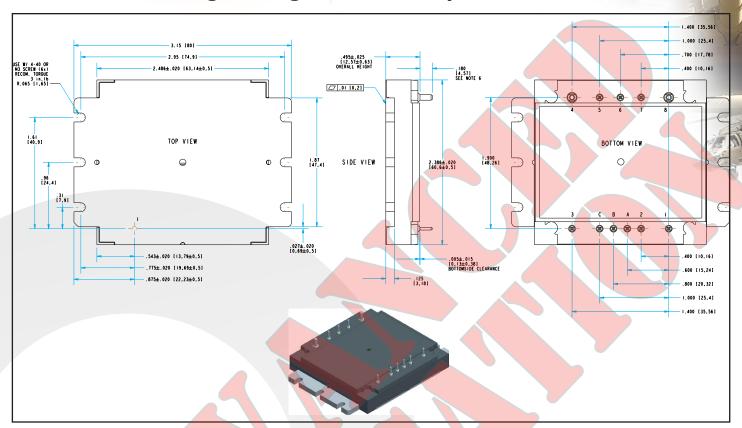
Notes:

- SENSE(-) should be connected to Vout(-) either remotely or at the converter.
- 2) Leave TRIM pin open for nominal output voltage.
- SENSE(+) should be connected to Vout(+) either remotely or at the converter.
- 4) Pins A, B, and C are populated on Full Feature version only.

Output: 5V

Current: 36A

Mechanical Drawing - Flanged Heatsink Option



NOTES

- Applied torque per screw should not exceed 5in-lb (3in-lb recommended).
- 2) Baseplate flatness tolerance is 0.01" (.25mm) TIR for surface.
- 3) Pins 1-3, 5-7, A, B, and C are 0.040" (1.02mm) diameter, with 0.080" (2.03mm) diameter standoff shoulders.
- 4) Pins 4 and 8 are 0.080" (2.03 mm) diameter with 0.125" (3.18 mm) diameter standoff shoulders.
- 5) All Pins: Material Copper Alloy; Finish Matte Tin over Nickel plate
- 6) Weight: 4.8 oz. (137 g) typical
- 7) Undimensioned components are shown for visual reference only.
- 8) All dimensions in inches (mm)

 Tolerances: x.xx +/-0.02 in. (x.x +/-0.5mm)

 x.xxx +/-0.010 in. (x.xx +/-0.25mm)
- 9) Workmanship: Meets or exceeds IPC-A610 Class II
- 10) Recommended pin length is 0.03" (0.76mm) greater than the PCB thickness.
- 11) A thermal interface material is required to assure proper heat transfer from the flanged baseplate to the cooling surface. Thermal grease, conductive pads, compounds, and other similar products are available from many heatsink manufacturers.

PIN DESIGNATIONS

	Pin	Name	Function				
	1	Vin(+)	Positive input voltage				
	2 ON/OFF		TTL input to turn converter on and off,				
_			referenced to Vin(–), with internal pull up.				
	Α	CLOCK SYNC	Clock synchronization				
	В	START SYNC	Startup synchronization				
	С	I SHARE	Single wire parallel signal				
	3	IN RTN	Input Return				
	4	OUT RTN	Output Return				
	5	SENSE(-)	Negative remote sense ¹				
	6 TRIM		Output voltage trim ²				
	7	SENSE(+)	Positive remote sense ³				
	8	Vout(+)	Positive output voltage				

Notes:

- SENSE(-) should be connected to Vout(-) either remotely or at the converter.
- 2) Leave TRIM pin open for nominal output voltage.
- SENSE(+) should be connected to Vout(+) either remotely or at the converter.
- 4) Pins A, B, and C are populated on Full Feature version only.

Output: 5V Current: 36A

Mil-COTS Qualification

Test Name	Details	# Tested (# Failed)	Consistent with MIL-STD-883F Method	Consistent with MIL-STD-883F Method 5005
Life Testing	Visual, mechanical and electrical testing before, during and after 1000 hour burn-in @ full load	15 (0)	Method 1005.8	
Shock-Vibration	Visual, mechanical and electrical testing before, during and after shock and vibration tests	5 (0)		MIL-STD-202, Methods 201A & 213B
Humidity	+85°C, 85% RH, 1000 hours, 2 minutes on/6 hours off	8 (0)	Method 1004.7	
Temperature Cycling	500 cycles of -55°C to +100°C (30 minute dwell at each temperature	10 (0)	Method 1010.8	Condition A
Solderability	15 pins	15 (0)	Method 2003	
DMT	-65°C to +110°C across full line and load specifications in 5°C steps	7 (0)		
Altitude	70,000 feet (21 km), see Note	2 (0)		

Note: A conductive cooling design is generally needed for high altitude applications because of naturally poor convective cooling at rare atmospheres.

Mil-COTS Screening

Screening	Process Description	S-Grade	M-Grade
Baseplate Operating Temperature		-55°C to +100°C	-55°C to +100°C
Storage Temperature		-65°C to +135°C	-65°C to +135°C
Pre-Cap Inspection	IPC-610, Class III	•	•
Temperature Cycling	Method 1010, Condition B, 10 Cycles		•
Burn-In	100°C Baseplate	12 Hours	96 Hours
Final Electrical Test	100%	25°C	-55°C, +25°C, +100°C
Final Visual Inspection	MIL-STD-2008	•	•

Output: 5V

Current: 36A

Ordering Information/ Part Numbering

Example MCOTS-C-28-05-HP-N-S-F

Not all combinations make valid part numbers, please contact SynQor for availability. See product summary page for details.

Family	Product	Input Voltage	Output Voltage	Package	Heatsink Option	Screening Level	Options
мсотѕ	C: Converter	28: 16-40V	1R8:1.8V 3R3:3.3V 05:5V 8R4:8.4V 12:12V 15:15V 19R1:19.1V 24:24V 28:28V 40:40V 48:48V	HP: Half Brick Peta	N:Normal Threaded D:Normal Non- Threaded F:Flanged	S: S-Grade M: M-Grade	[]:Standard Feature F:Full Feature

APPLICATION NOTES

A variety of application notes and technical white papers can be downloaded in pdf format from our website.

PATENTS

SynQor holds the following U.S. patents, one or more of which apply to each product listed in this document. Additional patent applications may be pending or filed in the future.

5,999,417	6,222,742	6,545,890	6,577,109	6,594,159
6,731,520	6,894,468	6,896,526	6,927,987	7,050,309
7,072,190	7,085,146	7,119,524	7,269,034	7,272,021
7,272,023	7,558,083	7,564,702	7,765,687	7,787,261

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USA

Warranty

SynQor offers a two (2) year limited warranty. Complete warranty information is listed on our website or is available upon request from SynQor.

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